

LineX Series CIS

High Speed
Compact Space
No-Distortion Imaging

High Speed / Compact Space / No-Distortion Imaging



CAMERA WIDTH, SUPPORT CUSTOMIZATION

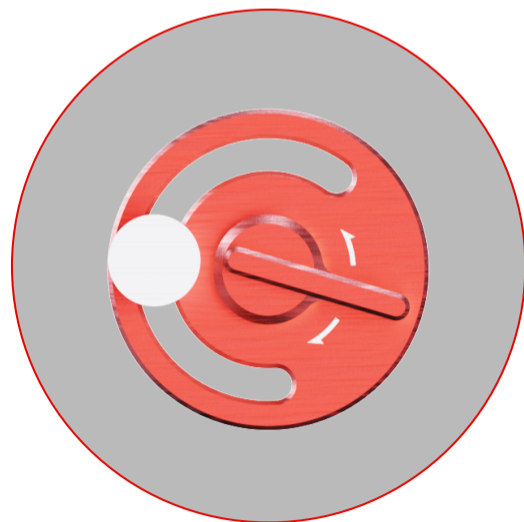
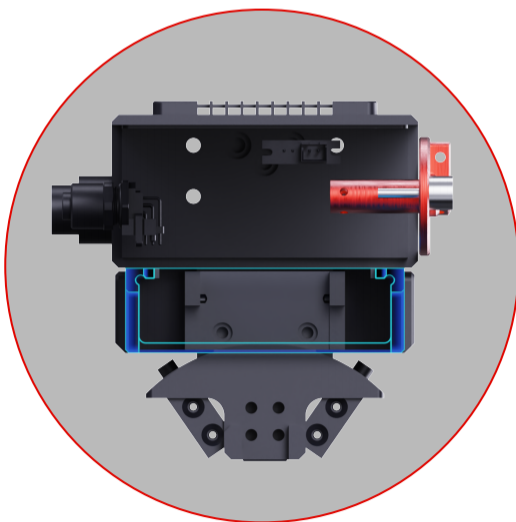
LineX series CIS

① Resolution: 300 DPI ~ 3600 DPI

② Adjustment completed within 3 seconds using a focusing mechanism

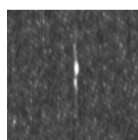
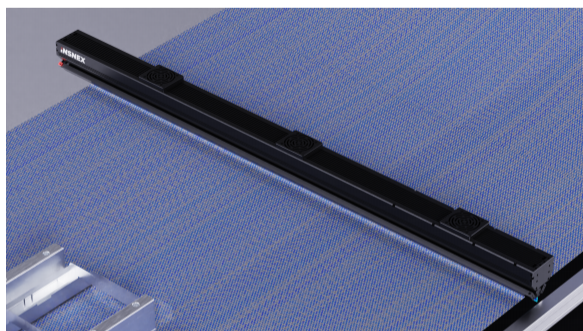
③ Scanning width: 35 mm ~ 2310 mm, customizable

④ Working distance: 7 mm / 15 mm / 30 mm / 50 mm, selectable

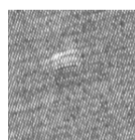


Application Cases

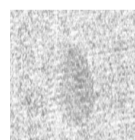
Fabric Inspection



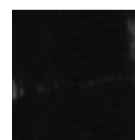
Weave Structure



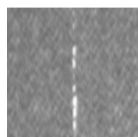
Block Defect



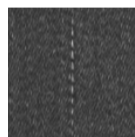
Oil Stains



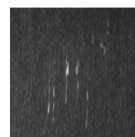
Shrinkage



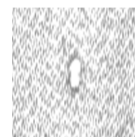
Foreign Fibers



Rough Warp

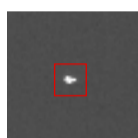
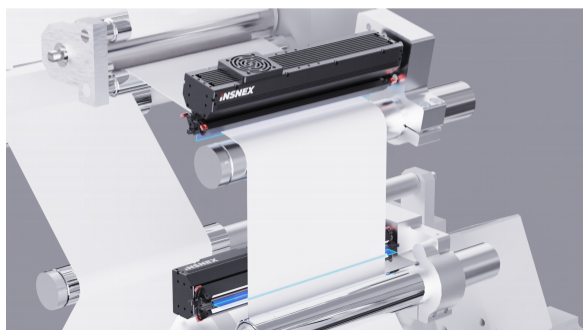


Warp and Weft Structure



Sizing

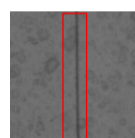
Surface Inspection of Battery Separator



White Spots



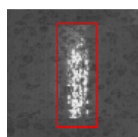
Fracture



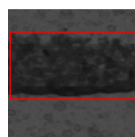
Folding



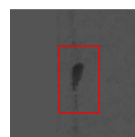
Dripping Adhesive



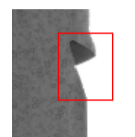
Missing Coating



Offset Printing

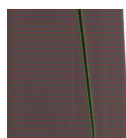
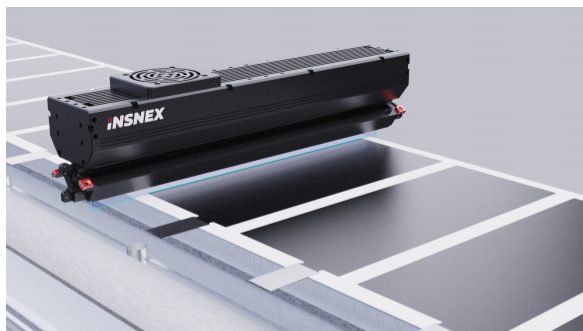


Black Spots

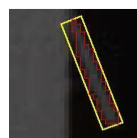


Edge Damage

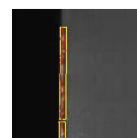
Surface Inspection of Electrode Sheets



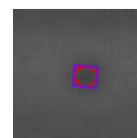
Wrinkles



Burrs



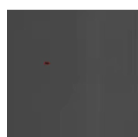
Edge Coating Peeling



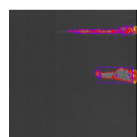
Dents



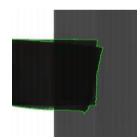
Adhesive Peeling



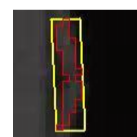
Adhesive Peeling



Output Hole

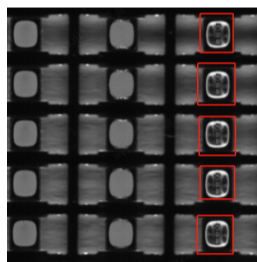
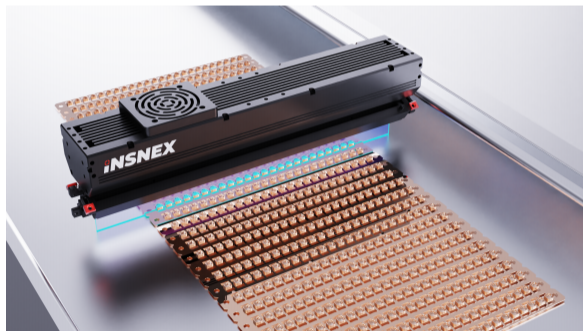


Foreign Object

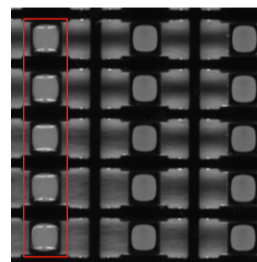


Edge Fracture

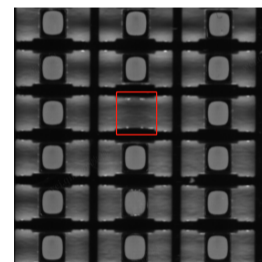
Electronic Components Inspection



Insufficient Adhesive



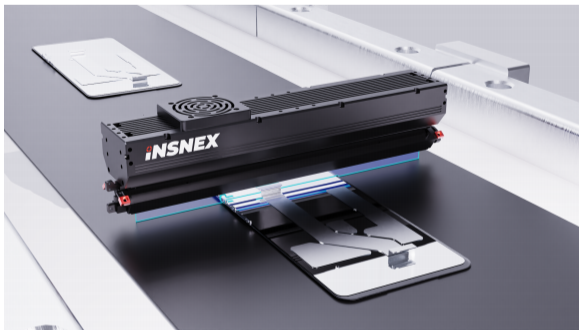
Excessive Adhesive



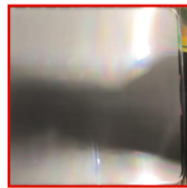
Damage

Application Cases

Screen Surface Inspection



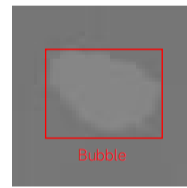
During the production of mobile phone displays, it's important to detect surface defects like bubbles and scratches. Bubbles with low contrast are hard to detect using regular imaging, but LineX can clearly show them.



Test object



Traditional camera

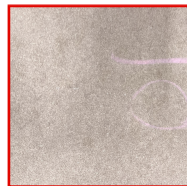


LineX

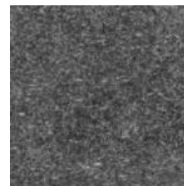
Wood Surface Inspection



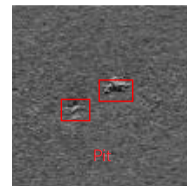
The original color of wood can mask defect features, making them hard to distinguish with the naked eye. LineX can filter out unnecessary patterns and clearly display defects.



Test object

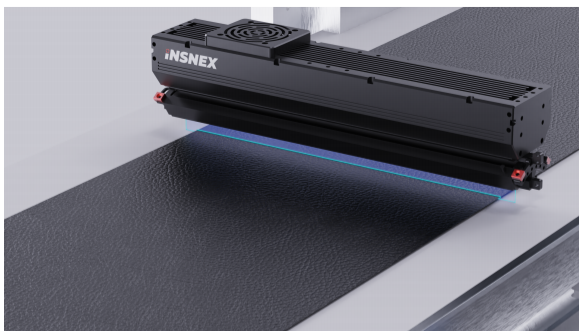


Traditional camera

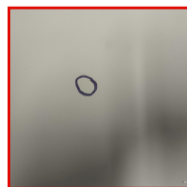


LineX

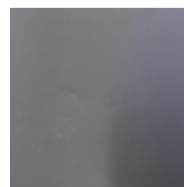
Leather Surface Inspection



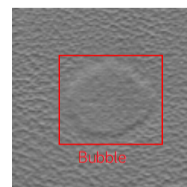
Common defects found on leather include loose stitches, improper fitting, insect eggs, pinholes, and blemishes. LineX can capture invisible texture details.



Test object



Traditional camera

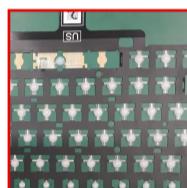


LineX

Keyboard Frame Inspection



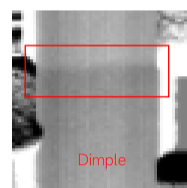
The creases on the keyboard frame are shallow, making it difficult for traditional 2D imaging techniques to identify the defect. LineX clearly displays the defect features for inspection.



Test object



Traditional camera



LineX

Application Cases

Printing Industry | Offset Printing and Color Management



LineX SerieX COLOR CIS excels in high-precision color recognition and clear imaging, accurately reproducing the subtle color differences and complex pattern structures of banknotes. Through advanced imaging technology and precise color correction, the texture, pattern and anti-counterfeiting mark of each banknote can be clearly captured.

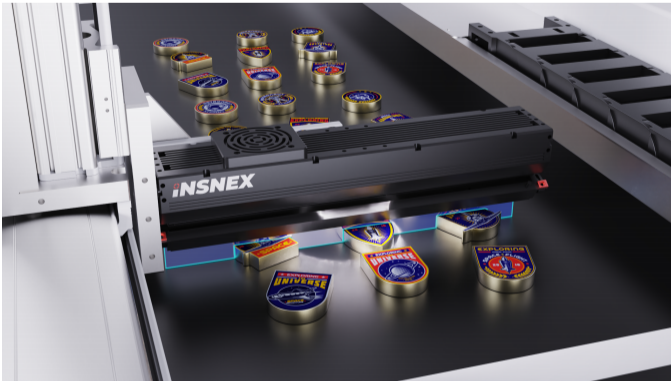
Printing Industry | Packaging Material Appearance Inspection



Relying on the 600dpi/900dpi 3-wire true-color high-speed macro camera, the multi-light source 2.5D fusion imaging technology and advanced AI algorithm are integrated to accurately identify dozens of defects such as surface dirt, scratches, printing defects, foreign objects and flaws in the sealed area of packaging materials. The system has strong anti-interference ability, effectively overcomes the misjudgment caused by material shake and wrinkle, ensures the full-scale quality check under the high-speed production line, and significantly improves customer brand perception.

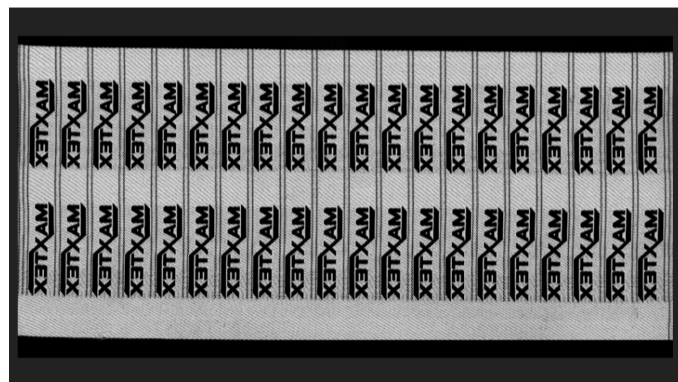
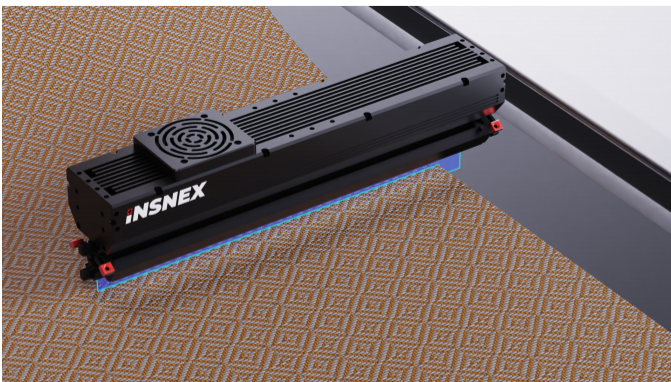
Application Cases

Digital Printing Industry | UV Printer CIS Guide



Using a 600 dpi macro camera instead of the traditional setup enables 1:1 distortion-free imaging. The system captures fabric edge features in real time, processes the images to automatically identify cutting lines or reference points, tracks fabric deformation, and corrects the path through software to ensure cutting accuracy.

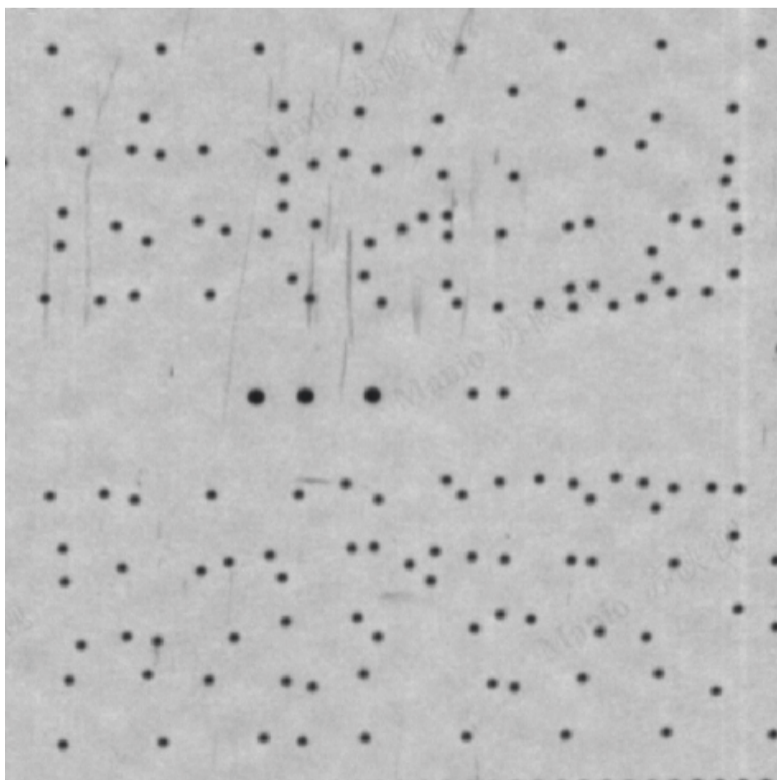
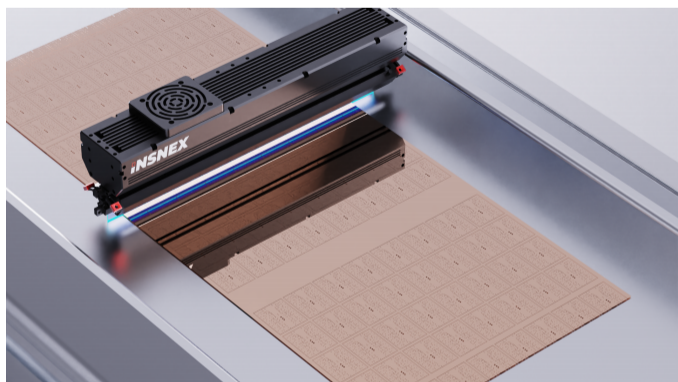
Machinery Industry | Cloth Cutting CIS Guide



A high-resolution 600dpi macro camera is used to replace the traditional line scan camera and telecentric lens to achieve 1:1 distortion-free imaging. The customer collects the edge features of the cloth in real time, and combines digital signal processing technology to process the image data to automatically identify the cutting line or locate the feature point. The system can automatically track the tensile deformation of the fabric and correct the path through computer software to ensure cutting accuracy.

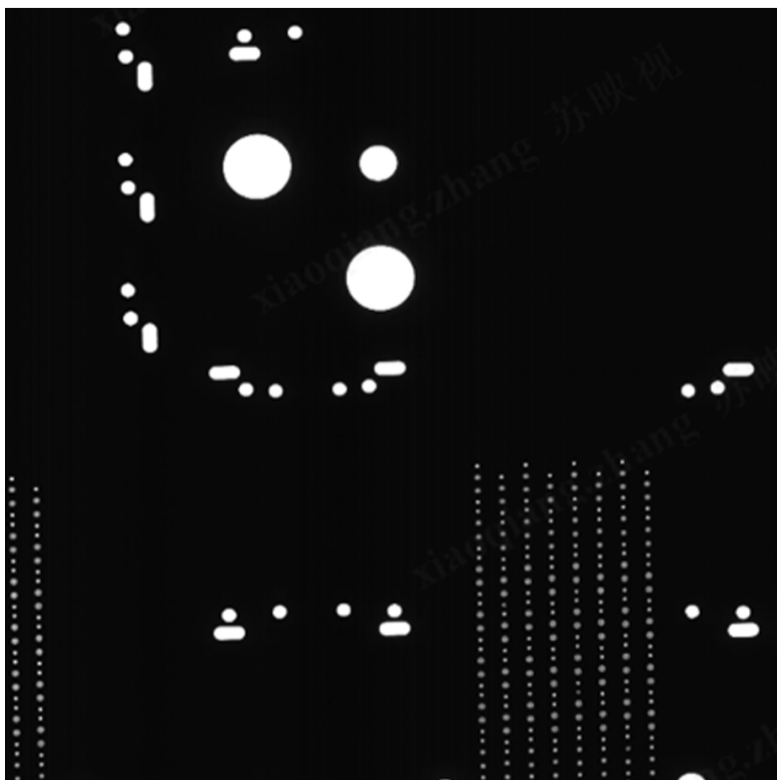
Application Cases

Semiconductor Industry | Lead Frame Appearance Inspection



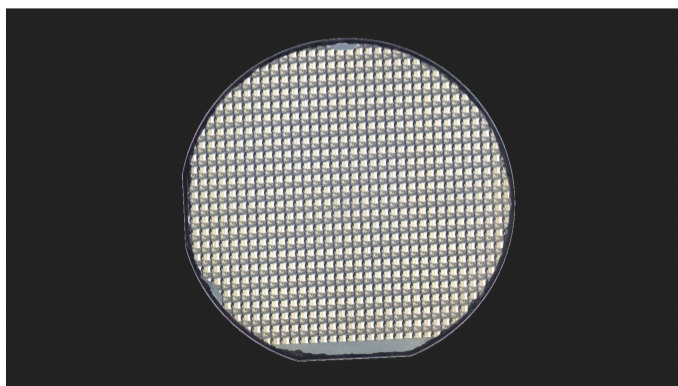
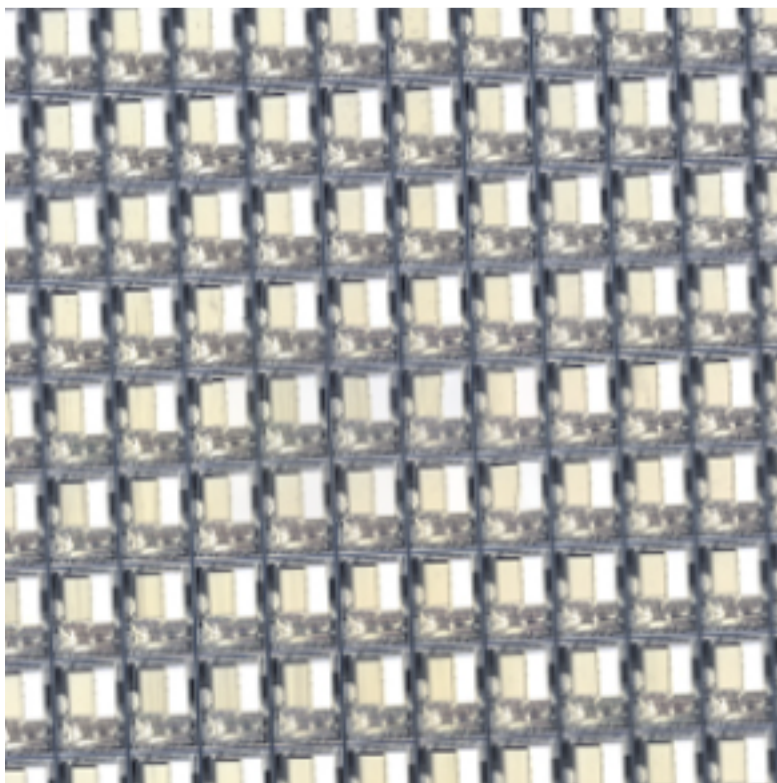
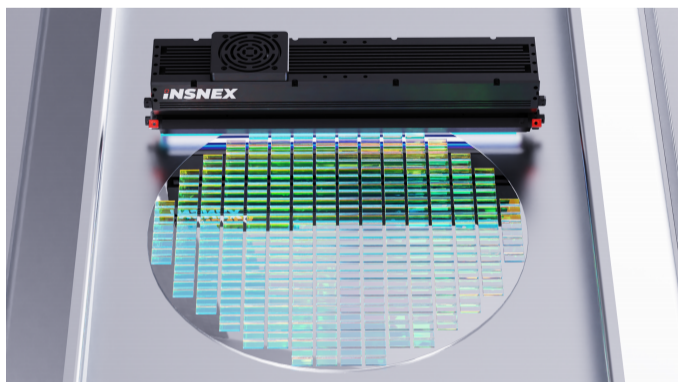
A semiconductor lead frame manufacturer integrated an 1800 dpi / 14 μ m color macro camera into its production line. With distortion-free imaging and AI algorithms, the system enables real-time defect detection. Using defect traceability for process improvements, the end user increased yield by over 1% and significantly boosted production efficiency.

PCB industry | PCB hole inspection machine application



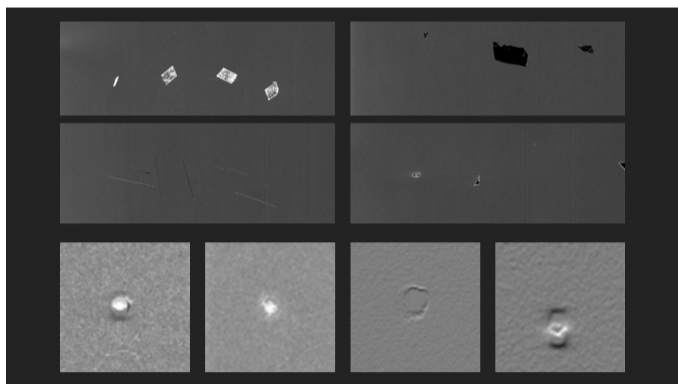
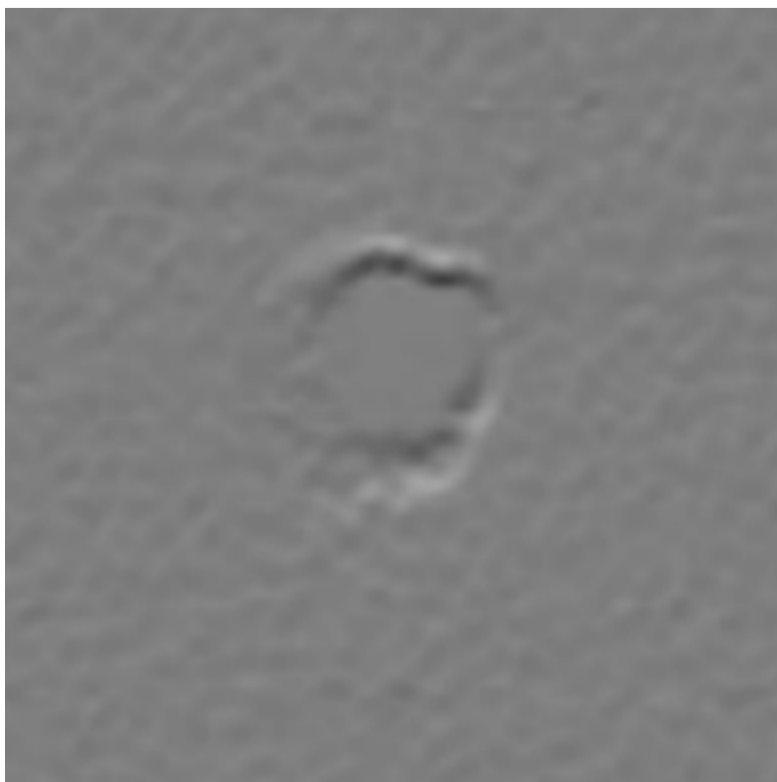
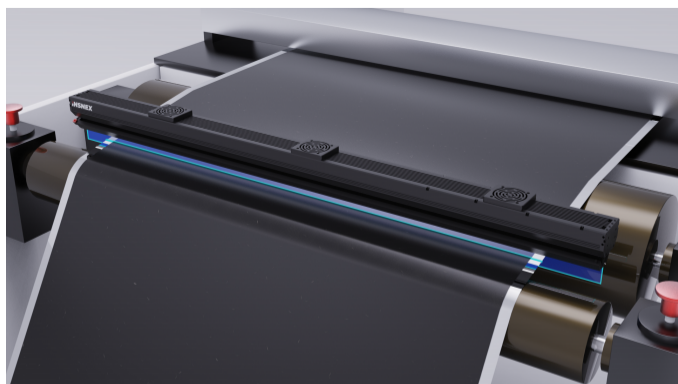
The vision system of the PCB hole inspector uses the 1800dpi/14 μ m macro camera with multi-angle and multi-light source collaborative imaging technology to clearly capture the inner wall details of the through hole and blind hole. The system feeds the detection data back to the drilling machine in real time, providing a solid data foundation for the PCB board factory to achieve drilling process optimization and comprehensive quality traceability.

Semiconductor Industry | Wafer Macro Defect Detection



The newly released 3600 dpi / 7 μ m macro camera, combined with time-division strobe and uniform illumination, enables fast and non-destructive wafer macro defect inspection. Since most micro-defects appear as macro defects, integrating CIS monitoring across 500+ processes from wafer to packaging provides 100% early-warning coverage and real-time feedback for process optimization and yield improvement.

Lithium battery industry | Gravure coating machine electrode defect detection



INSNEX's CIS solution empowers leading battery manufacturers to upgrade gravure coating inspection. With a single 1550 mm wide, zero-stitching camera and 600 dpi high-precision imaging, it eliminates stitching errors, reliably detects micron-level defects, raises yield to 99.8%, and significantly reduces maintenance costs.

SPECIFICATIONS

LineX CIS PLUS (V25-0828)

NO.	Mono or Color	Interface	FOV (mm)	Resolution (dpi)	Accuracy (um)	DOF (mm)	WD (mm)	Line Rate (kHz)	WS (m/s)	Ethernet Ports	Pixel (K)	CIS Module	Size
1	Mono	10GigE	190.00	300	84	±1.3	15	110	9.3	1	2.25	INS-CHVS-190-10GM-AA	330mm*70mm*108mm
2	Mono	10GigE	190.00	600	42	±1.3	15	66	2.8	1	4.50	INS-CHVS-190-10GM-BB	330mm*70mm*108mm
3	Mono	10GigE	242.00	300	84	±1.3	15	110	9.3	1	2.87	INS-CHVS-242-10GM-AA	330mm*70mm*108mm
4	Mono	10GigE	242.00	600	42	±1.3	15	66	2.8	1	5.73	INS-CHVS-242-10GM-BB	330mm*70mm*108mm
5	Mono	10GigE	363.00	600	42	±1.3	15	66	2.8	1	8.59	INS-CHVS-363-10GM-BB	450mm*90mm*108mm
6	Mono	10GigE	363.00	300	84	±1.3	15	110	9.3	1	4.30	INS-CHVS-363-10GM-AA	450mm*90mm*108mm
7	Mono	10GigE	366.00	1200	21	±1.3	15	11	0.23	1	17.30	INS-CHVS-366-10GM-CC	450mm*90mm*108mm
8	Mono	10GigE	415.00	300	84	±1.3	15	110	9.3	1	4.92	INS-CHVS-415-10GM-AA	500mm*90mm*108mm
9	Mono	10GigE	415.00	600	42	±1.3	15	66	2.8	1	9.82	INS-CHVS-415-10GM-BB	500mm*90mm*108mm
10	Mono	10GigE	550.00	300	84	±1.3	15	110	9.3	1	6.56	INS-CHVS-550-10GM-AA	630mm*90mm*108mm
11	Mono	10GigE	550.00	300	84	±1.3	15	150	12.6	2	6.56	INS-CHVS-550-10GM-AA1	630mm*90mm*108mm
12	Mono	10GigE	550.00	600	42	±1.3	15	66	2.8	1	13.09	INS-CHVS-550-10GM-BB	630mm*90mm*108mm
13	Mono	10GigE	550.00	600	42	±1.3	15	95	4	2	13.09	INS-CHVS-550-10GM-BA	630mm*90mm*108mm
14	Mono	10GigE	550.00	1200	21	±1.3	15	11	0.23	1	23.35	INS-CHVS-550-10GM-CC	630mm*90mm*108mm
15	Mono	10GigE	813.00	300	84	±1.3	15	110	9.3	2	9.63	INS-CHVS-813-10GM-AA	896mm*90mm*108mm
16	Mono	10GigE	813.00	600	42	±1.3	15	66	2.8	2	19.22	INS-CHVS-813-10GM-BB	896mm*90mm*108mm
17	Mono	10GigE	934.00	300	84	±1.3	15	110	9.3	2	11.07	INS-CHVS-934-10GM-AA	1041mm*90mm*108mm
18	Mono	10GigE	934.00	300	84	±1.3	15	150	12.6	3	11.07	INS-CHVS-934-10GM-AA1	1041mm*90mm*108mm
19	Mono	10GigE	934.00	600	42	±1.3	15	66	2.8	2	22.09	INS-CHVS-934-10GM-BB	1041mm*90mm*108mm
20	Mono	10GigE	934.00	600	42	±1.3	15	95	4	3	22.09	INS-CHVS-934-10GM-BA	1041mm*90mm*108mm
21	Mono	10GigE	940.00	1200	21	±1.3	15	11	0.23	2	44.42	INS-CHVS-940-10GM-CC	1041mm*90mm*108mm
22	Mono	10GigE	1,245.00	300	84	±1.3	15	110	9.3	2	14.76	INS-CHVS-1245-10GM-AA	1332mm*90mm*117mm
23	Mono	10GigE	1,245.00	600	42	±1.3	15	66	2.8	2	29.45	INS-CHVS-1245-10GM-BB	1332mm*90mm*117mm
24	Mono	10GigE	1,349.00	300	84	±1.3	15	110	9.3	3	15.99	INS-CHVS-1350-10GM-AA	1436mm*90mm*117mm
25	Mono	10GigE	1,349.00	300	84	±1.3	15	150	12.6	4	15.99	INS-CHVS-1350-10GM-AA1	1436mm*90mm*117mm
26	Mono	10GigE	1,349.00	600	42	±1.3	15	66	2.8	3	31.90	INS-CHVS-1350-10GM-BB	1436mm*90mm*117mm
27	Mono	10GigE	1,349.00	600	42	±1.3	15	95	4	4	31.90	INS-CHVS-1350-10GM-BA	1436mm*90mm*117mm
28	Mono	10GigE	1,539.00	300	84	±1.3	15	110	9.3	3	18.24	INS-CHVS-1550-10GM-AA	1628mm*90mm*117mm
29	Mono	10GigE	1,539.00	300	84	±1.3	15	150	12.6	4	18.24	INS-CHVS-1550-10GM-AA1	1628mm*90mm*117mm
30	Mono	10GigE	1,539.00	600	42	±1.3	15	66	2.8	3	36.40	INS-CHVS-1550-10GM-BB	1628mm*90mm*117mm
31	Mono	10GigE	1,539.00	600	42	±1.3	15	95	4	4	36.40	INS-CHVS-1550-10GM-BA	1628mm*90mm*117mm
32	Mono	10GigE	1,537.00	1200	21	±1.3	15	11	0.23	3	72.65	INS-CHVS-1550-10GM-CC	1628mm*90mm*117mm
33	Mono	10GigE	1,937.00	300	84	±1.3	15	110	9.3	4	22.87	INS-CHVS-1950-10GM-AA	TBD
34	Mono	10GigE	1,937.00	600	42	±1.3	15	66	2.8	4	45.76	INS-CHVS-1950-10GM-BB	TBD

SPECIFICATIONS

LineX CIS MAX (V25-0903)

NO.	Mono or Color	Interface	FOV (mm)	Resolution (dpi)	Accuracy (um)	DOF (mm)	WD (mm)	Line Rate (kHz)	WS (m/s)	Ethernet Ports	Pixel (K)	CIS Module	Size
1	Mono	10GigE	165.00	900	28	±1.3	15	160	4.48	1	5.89	INS-LXM-165-10GM-9F	310mm*90mm*115mm
2	Mono	10GigE	165.00	900	28	±1.3	15	80	2.24	1	5.89	INS-LXM-165-10GM-9M	310mm*90mm*115mm
3	Mono	10GigE	165.00	1800	14	±1.3	15	40	0.56	1	11.79	INS-LXM-165-10GM-18L	310mm*90mm*115mm
4	Mono	10GigE	165.00	1800	14	±1.3	30	40	0.56	1	11.79	INS-LXM-165-10GM-18L-WD30	310mm*90mm*147mm
5	Mono	10GigE	165.00	1800	14	±1.3	15	80	1.12	1	11.79	INS-LXM-165-10GM-18M	310mm*90mm*115mm
6	Mono	10GigE	328.00	900	28	±1.3	15	80	2.24	1	11.71	INS-LXM-328-10GM-9M	404mm*90mm*106mm
7	Mono	10GigE	328.00	1800	14	±1.3	15	40	0.56	1	23.43	INS-LXM-328-10GM-18L	404mm*90mm*106mm
8	Mono	10GigE	328.00	1800	14	±1.3	15	80	1.12	2	23.43	INS-LXM-328-10GM-18M	404mm*90mm*147mm
9	Mono	10GigE	328.00	900	28	±1.3	15	160	4.48	2	11.71	INS-LXM-328-10GM-9F	404mm*90mm*106mm
10	Mono	10GigE	328.00	1800	14	±1.3	30	40	0.56	1	23.43	INS-LXM-328-10GM-18L-WD30	404mm*90mm*140mm
11	Mono	10GigE	360.00	900	28	±1.3	15	80	2.24	2	12.86	INS-LXM-360-10GM-9M	529mm*90mm*117mm
12	Mono	10GigE	360.00	1800	14	±1.3	15	40	0.56	2	25.71	INS-LXM-360-10GM-18L	529mm*90mm*117mm
13	Mono	10GigE	360.00	1800	14	±1.3	15	80	1.12	3	25.71	INS-LXM-360-10GM-18M	577mm*108mm*152mm
14	Mono	10GigE	490.00	900	28	±1.3	15	160	4.48	3	17.50	INS-LXM-490-10GM-9F	610mm*180mm*106mm
15	Mono	10GigE	490.00	1800	14	±1.3	30	40	0.56	2	35.00	INS-LXM-490-10GM-18L-WD30	TBD
16	Mono	10GigE	490.00	900	28	±1.3	15	80	2.24	2	17.50	INS-LXM-490-10GM-9M	610mm*90mm*109mm
17	Mono	10GigE	490.00	1800	14	±1.3	15	40	0.56	2	35.00	INS-LXM-490-10GM-18L	610mm*90mm*109mm
18	Mono	10GigE	490.00	1800	14	±1.3	15	80	1.12	3	35.00	INS-LXM-490-10GM-18M	TBD
19	Mono	10GigE	656.00	900	28	±1.3	15	160	4.48	4	23.43	INS-LXM-656-10GM-9F	730mm*90mm*106mm
20	Mono	10GigE	656.00	1800	14	±1.3	30	40	0.56	2	46.86	INS-LXM-656-10GM-18L-WD30	TBD
21	Mono	10GigE	656.00	900	28	±1.3	15	80	2.24	2	23.43	INS-LXM-656-10GM-9M	730mm*90mm*106mm
22	Mono	10GigE	656.00	1800	14	±1.3	15	40	0.56	2	46.86	INS-LXM-656-10GM-18L	730mm*90mm*106mm
23	Mono	10GigE	656.00	1800	14	±1.3	15	80	1.12	4	46.86	INS-LXM-656-10GM-18M	737mm*108mm*158mm
24	Mono	10GigE	820.00	900	28	±1.3	15	160	4.48	5	29.29	INS-LXM-820-10GM-9F	TBD
25	Mono	10GigE	820.00	1800	14	±1.3	30	40	0.56	3	58.57	INS-LXM-820-10GM-18L-WD30	TBD
26	Mono	10GigE	820.00	900	28	±1.3	15	80	2.24	3	29.29	INS-LXM-820-10GM-9M	895mm*90mm*109mm
27	Mono	10GigE	820.00	1800	14	±1.3	15	40	0.56	3	58.57	INS-LXM-820-10GM-18L	895mm*90mm*109mm
28	Mono	10GigE	820.00	1800	14	±1.3	15	80	1.12	5	58.57	INS-LXM-820-10GM-18M	TBD
29	Mono	10GigE	950.00	900	28	±1.3	15	160	4.48	6	33.93	INS-LXM-950-10GM-9F	1043mm*90mm*104mm
30	Mono	10GigE	950.00	900	28	±1.3	15	80	2.24	3	33.93	INS-LXM-950-10GM-9M	1043mm*90mm*118mm
31	Mono	10GigE	950.00	1800	14	±1.3	15	40	0.56	3	67.86	INS-LXM-950-10GM-18L	1043mm*90mm*118mm
32	Mono	10GigE	950.00	1800	14	±1.3	15	80	1.12	6	67.86	INS-LXM-950-10GM-18M	TBD
33	Mono	10GigE	1,148.00	900	28	±1.3	15	80	2.24	4	41.00	INS-LXM-1148-10GM-9M	1256mm*90mm*118mm
34	Mono	10GigE	1,148.00	1800	14	±1.3	15	40	0.56	4	82.00	INS-LXM-1148-10GM-18L	1424mm*90mm*118mm
35	Mono	10GigE	1,148.00	1800	14	±1.3	15	80	1.12	7	82.00	INS-LXM-1148-10GM-18M	TBD
36	Mono	10GigE	1,312.00	900	28	±1.3	15	80	2.24	4	46.86	INS-LXM-1312-10GM-9M	1424mm*90mm*117mm
37	Mono	10GigE	1,312.00	1800	14	±1.3	15	40	0.56	4	93.71	INS-LXM-1312-10GM-18L	1424mm*90mm*117mm
38	Mono	10GigE	1,312.00	1800	14	±1.3	15	80	1.12	8	93.71	INS-LXM-1312-10GM-18M	TBD
39	Mono	10GigE	1,476.00	900	28	±1.3	15	80	2.24	5	52.71	INS-LXM-1476-10GM-9M	1588mm*90mm*117mm
40	Mono	10GigE	1,476.00	1800	14	±1.3	15	40	0.56	5	105.43	INS-LXM-1476-10GM-18L	1588mm*90mm*117mm
41	Mono	10GigE	1,476.00	1800	14	±1.3	15	80	1.12	9	105.43	INS-LXM-1476-10GM-18M	TBD

SPECIFICATIONS

LineX CIS MAX PRO (V25-0828)

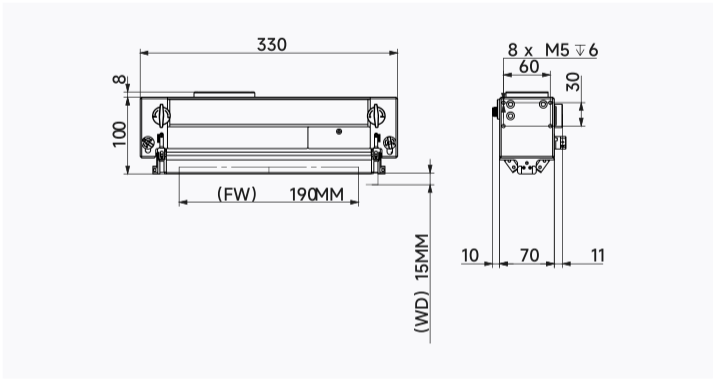
NO.	Mono or Color	Interface	FOV (mm)	Resolution (dpi)	Accuracy (um)	DOF (mm)	WD (mm)	Line Rate (kHz)	WS (m/s)	Ethernet Pots	Pixel (K)	CIS Module	Size
1	Mono	10GigE	165.00	3600	7	±0.7	7	40	0.28	1	23.57	INS-LXM-165-10GM-36L-WD7	310mm*90mm*107mm
2	Mono	10GigE	328.00	3600	7	±0.7	7	40	0.28	2	46.86	INS-LXM-328-10GM-36L-WD7	513mm*90mm*109mm
3	Mono	10GigE	360.00	3600	7	±0.7	7	40	0.28	3	51.43	INS-LXM-360-10GM-36L-WD7	542mm*180mm*105mm
4	Mono	10GigE	490.00	3600	7	±0.7	7	40	0.28	3	70.29	INS-LXM-490-10GM-36L-WD7	TBD
5	Mono	10GigE	656.00	3600	7	±0.7	7	40	0.28	4	93.71	INS-LXM-656-10GM-36L-WD7	730mm*180mm*105mm
6	Mono	10GigE	820.00	3600	7	±0.7	7	40	0.28	5	117.14	INS-LXM-820-10GM-36L-WD7	TBD
7	Mono	10GigE	950.00	3600	7	±0.7	7	40	0.28	6	135.71	INS-LXM-950-10GM-36L-WD7	TBD
8	Mono	10GigE	1148.00	3600	7	±0.7	7	40	0.28	7	164	INS-LXM-1148-10GM-36L-WD7	TBD
9	Mono	10GigE	1312.00	3600	7	±0.7	7	40	0.28	8	187.43	INS-LXM-1312-10GM-36L-WD7	TBD
10	Mono	10GigE	1476.00	3600	7	±0.7	7	40	0.28	9	210.86	INS-LXM-1476-10GM-36L-WD7	TBD

LineX CIS COLOR (V25-0828)

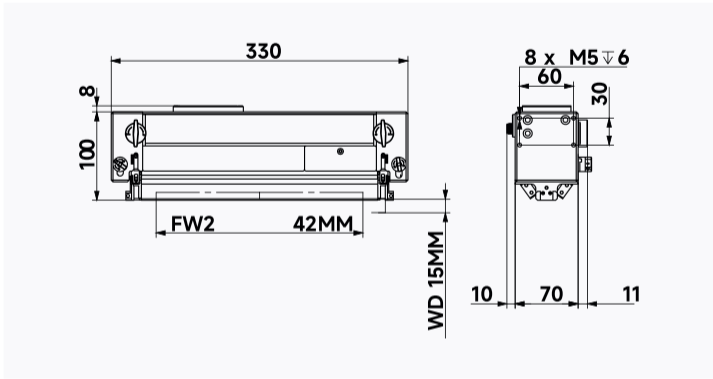
NO.	Mono or Color	Interface	FOV (mm)	Resolution (dpi)	Accuracy (um)	DOF (mm)	WD (mm)	Line Rate (kHz)	WS (m/s)	Ethernet Pots	Pixel (K)	CIS Module	Size
1	Color	10GigE	165.00	1800	14	±1.3	15	27	0.37	1	11.79	INS-LXM-165-10GC-18L	310mm*90mm*115mm
2	Color	10GigE	165.00	900	28	±1.3	15	27	0.75	1	5.89	INS-LXM-165-10GC-9L	310mm*90mm*115mm
3	Color	10GigE	270.00	1800	14	±1.3	15	19	0.26	1	19.29	INS-LXM-270-10GC-18L	404mm*90mm*109mm
4	Color	10GigE	270.00	900	28	±1.3	15	27	0.75	1	9.64	INS-LXM-270-10GC-9L	404mm*90mm*109mm
5	Color	10GigE	190.00	600	42	±1.3	15	36	1.5	1	4.50	INS-CHVS-190-10GC-BB	330mm*70mm*108mm
6	Color	10GigE	311.00	600	42	±1.3	15	36	1.5	1	7.34	INS-CHVS-311-10GC-BB	450mm*90mm*108mm
7	Color	10GigE	311.00	600	42	±1.3	15	66	2.8	2	7.34	INS-CHVS-311-10GC-BA	TBD
8	Color	10GigE	311.00	300	84	±1.3	15	110	9.3	2	3.67	INS-CHVS-311-10GC-AA	TBD
9	Color	10GigE	363.00	600	42	±1.3	15	36	1.5	1	8.59	INS-CHVS-363-10GC-BB	450mm*90mm*108mm
10	Color	10GigE	363.00	600	42	±1.3	15	66	2.8	3	8.59	INS-CHVS-363-10GC-BA	TBD
11	Color	10GigE	363.00	300	84	±1.3	15	110	9.3	3	4.30	INS-CHVS-363-10GC-AA	TBD
12	Color	10GigE	550.00	600	42	±1.3	15	36	1.5	2	13.09	INS-CHVS-550-10GC-BB	630mm*90mm*108mm
13	Color	10GigE	550.00	600	42	±1.3	15	66	2.8	4	13.09	INS-CHVS-550-10GC-BA	TBD
14	Color	10GigE	550.00	300	84	±1.3	15	110	9.3	4	6.54	INS-CHVS-550-10GC-AA	TBD
15	Color	10GigE	934.00	600	42	±1.3	15	36	1.5	3	22.09	INS-CHVS-934-10GC-BB	1041mm*90mm*108mm
16	Color	10GigE	934.00	600	42	±1.3	15	66	2.8	6	22.09	INS-CHVS-934-10GC-BA	TBD
17	Color	10GigE	934.00	300	84	±1.3	15	110	9.3	6	11.04	INS-CHVS-934-10GC-AA	TBD
18	Color	10GigE	1539.00	600	42	±1.3	15	36	1.5	4	36.40	INS-CHVS-1550-10GC-BB	1628mm*90mm*117mm
19	Color	10GigE	490.00	900	28	±1.3	15	27	0.75	2	17.50	INS-LXM-490-10GC-9L	TBD
20	Color	10GigE	490.00	1800	14	±1.3	15	19	0.26	2	35.00	INS-LXM-490-10GC-18L	TBD
21	Color	10GigE	656.00	900	28	±1.3	15	27	0.75	3	23.43	INS-LXM-656-10GC-9L	TBD
22	Color	10GigE	656.00	1800	14	±1.3	15	19	0.26	3	46.86	INS-LXM-656-10GC-18L	TBD
23	Color	10GigE	820.00	1800	14	±1.3	15	19	0.26	4	58.57	INS-LXM-820-10GC-18L	TBD
24	Color	10GigE	820.00	900	28	±1.3	15	27	0.75	4	29.29	INS-LXM-820-10GC-9L	TBD
25	Color	10GigE	1080.00	1800	14	±1.3	15	19	0.26	5	77.14	INS-LXM-1080-10GC-18L	TBD
26	Color	10GigE	1080.00	900	28	±1.3	15	27	0.75	5	38.57	INS-LXM-1080-10GC-9L	TBD

DIMENSION DRAWING (PLUS)

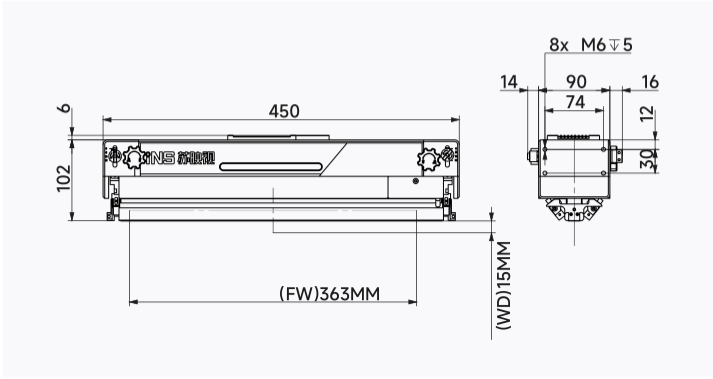
INS-CHVS-190-10GM - (AA,BB)



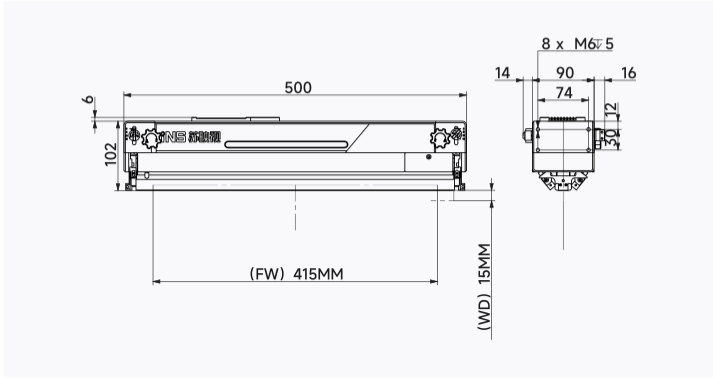
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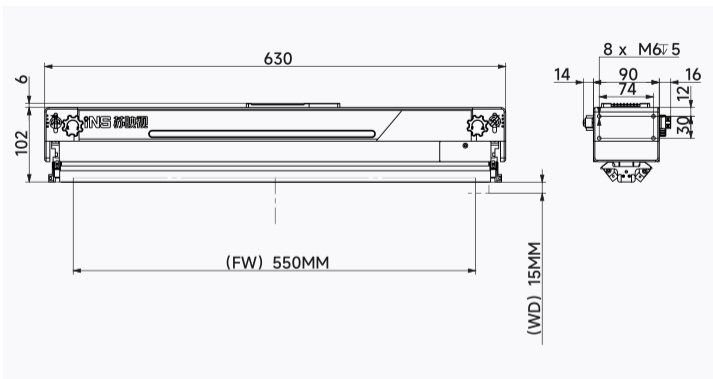
INS-CHVS-363-10GM-(AA,BB,CC)



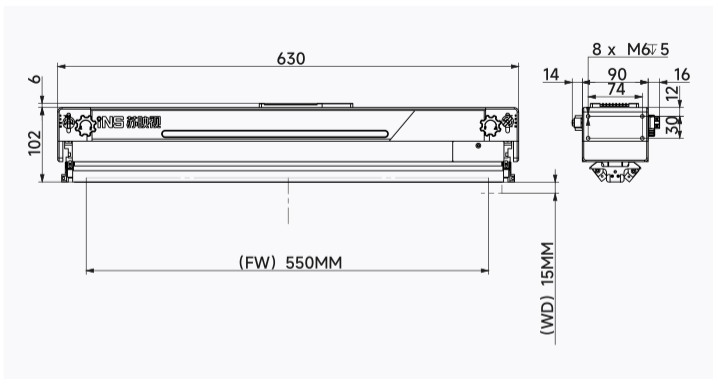
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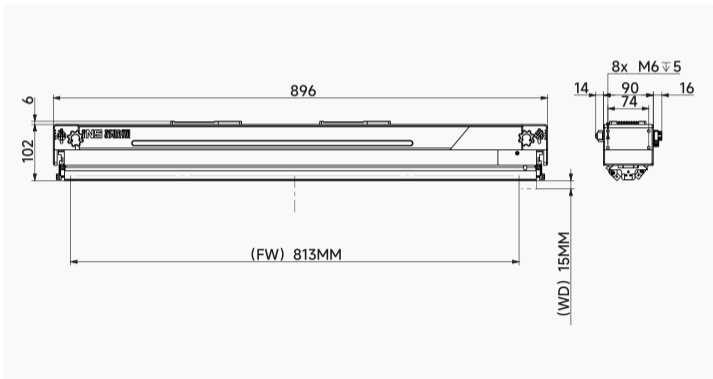
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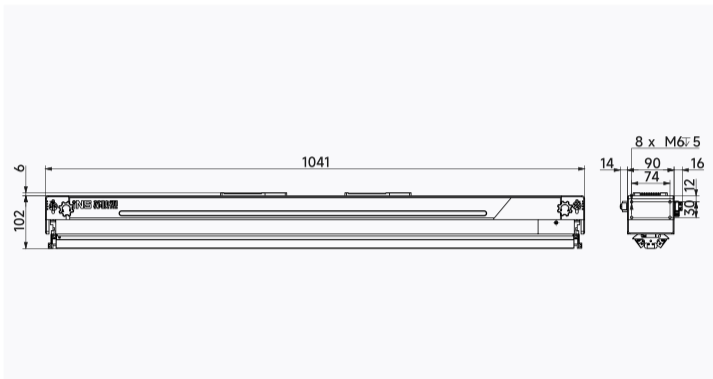
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INS-CHVS-813-10GM-(AA,BB)

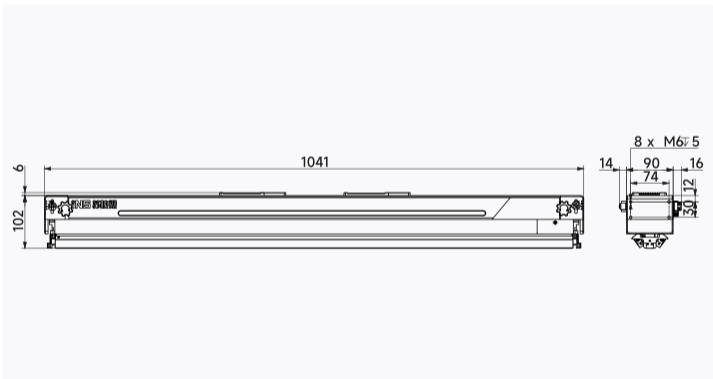


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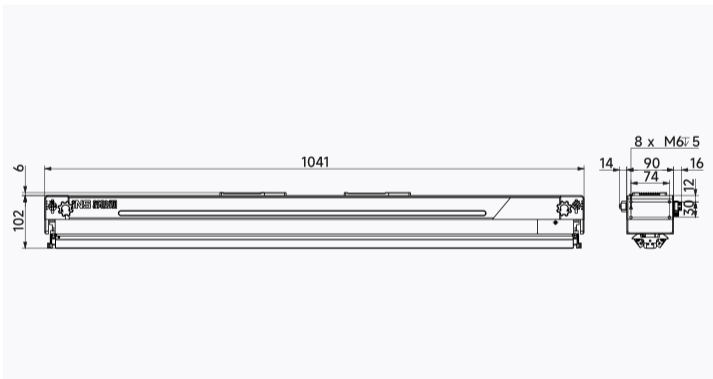


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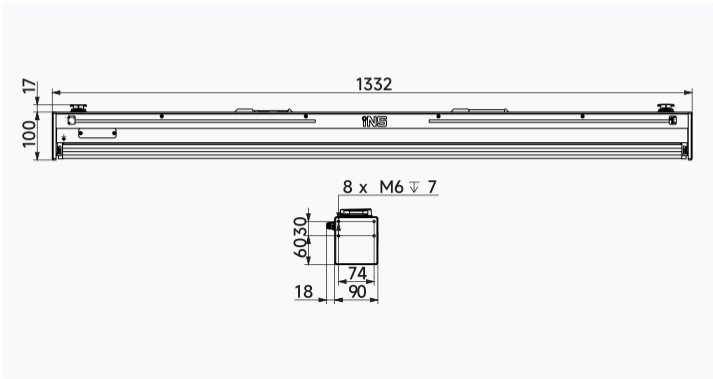
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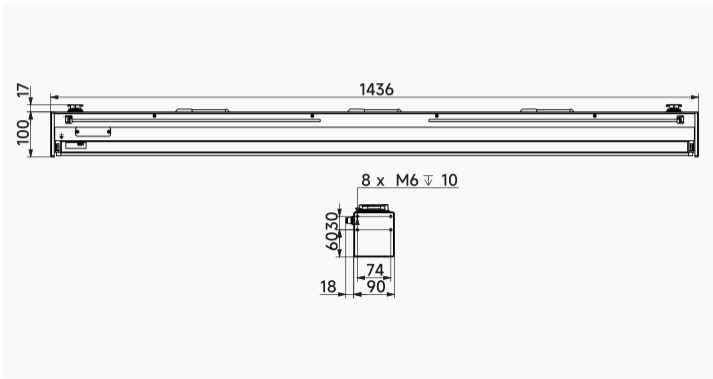
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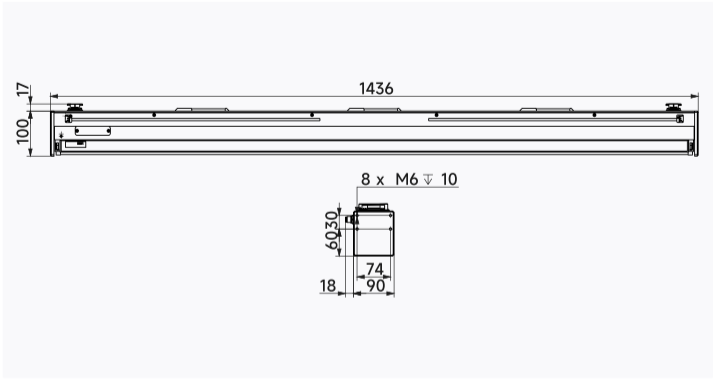
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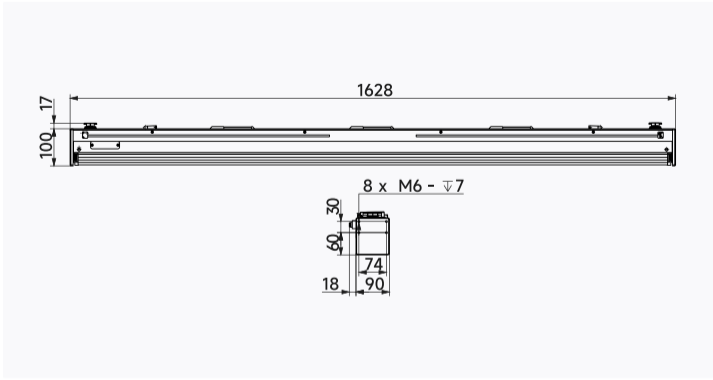
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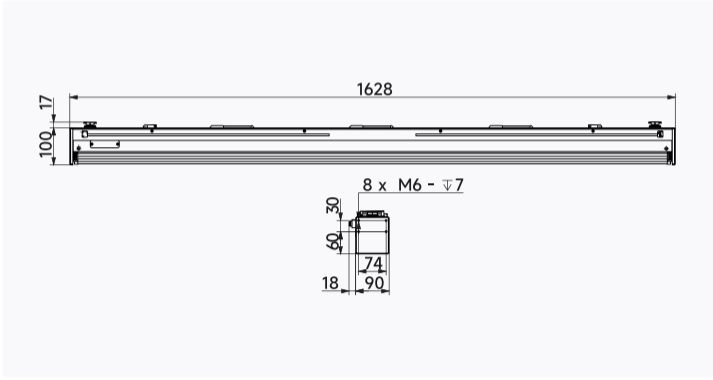
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INS-CHVS-1550-10GM-(AA,BB,CC)

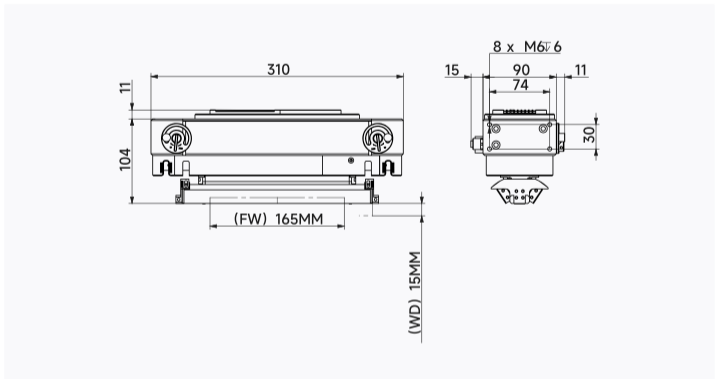


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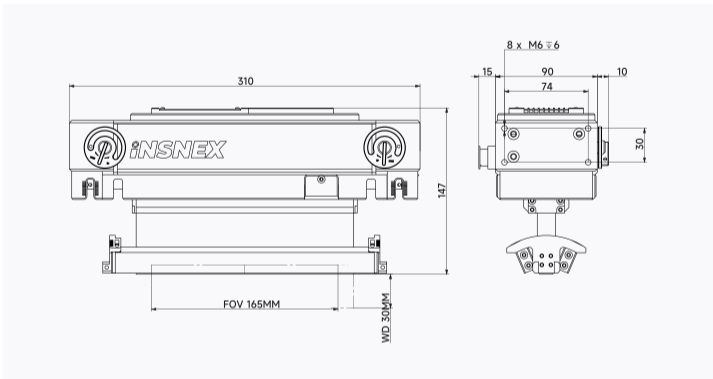


DIMENSION DRAWING (MAX)

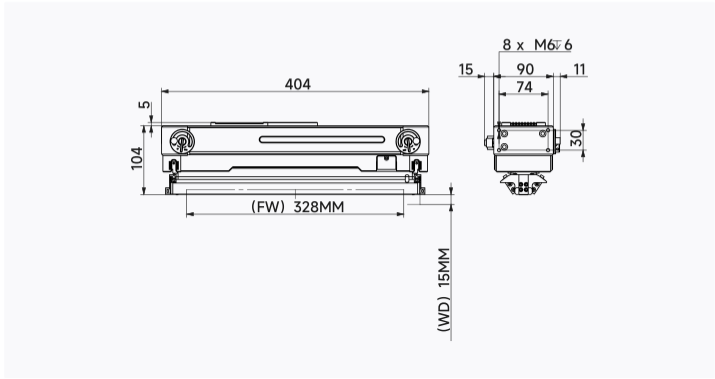
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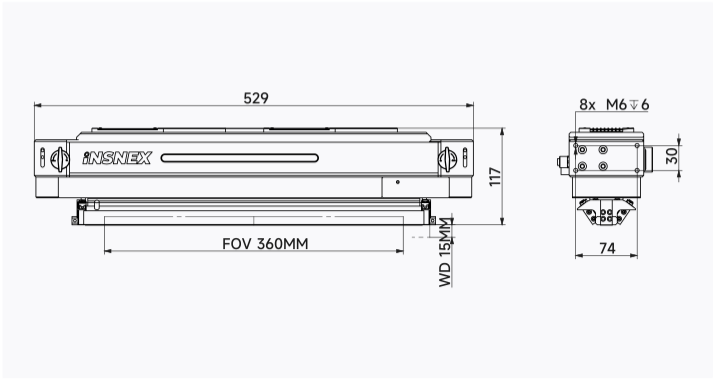
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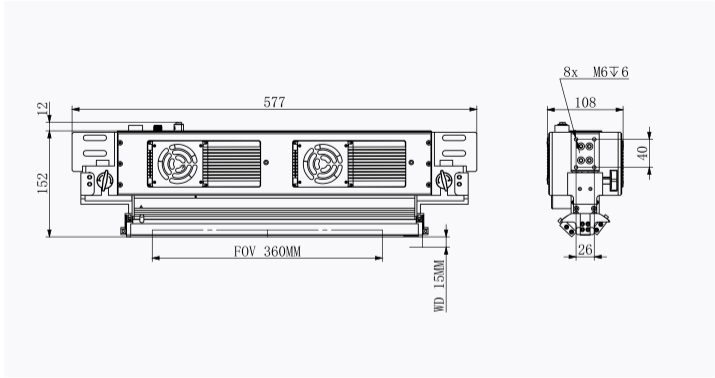
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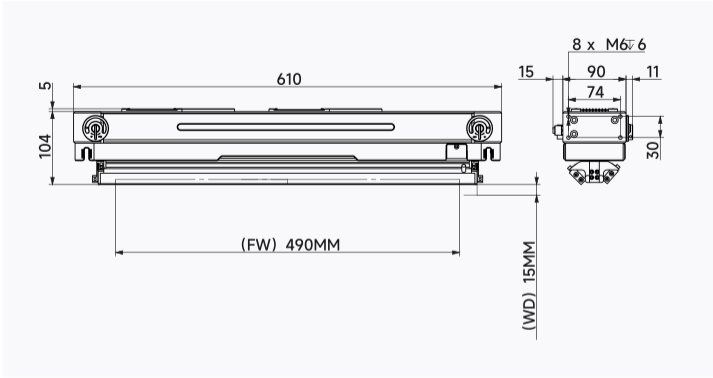
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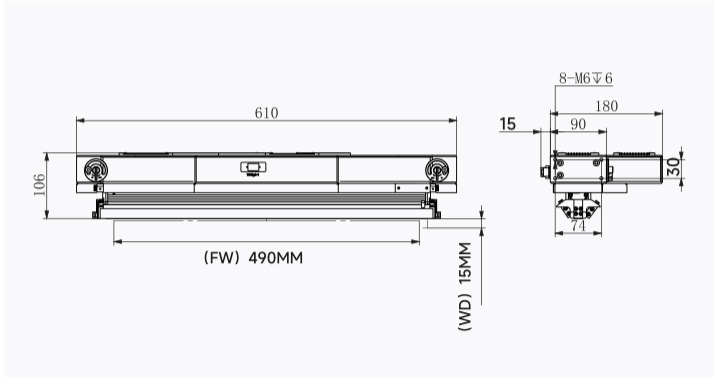
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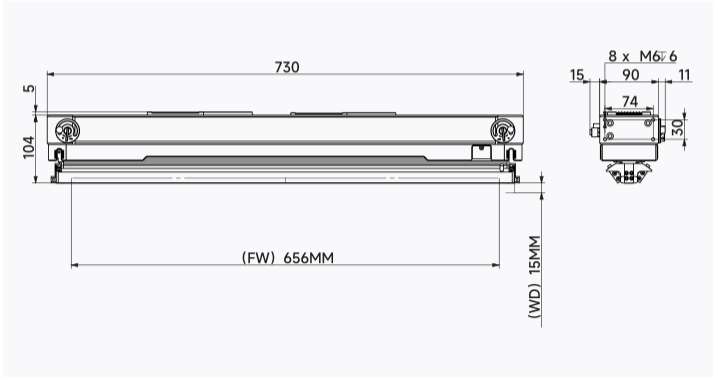
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INS-LXM-490-10GM-9F

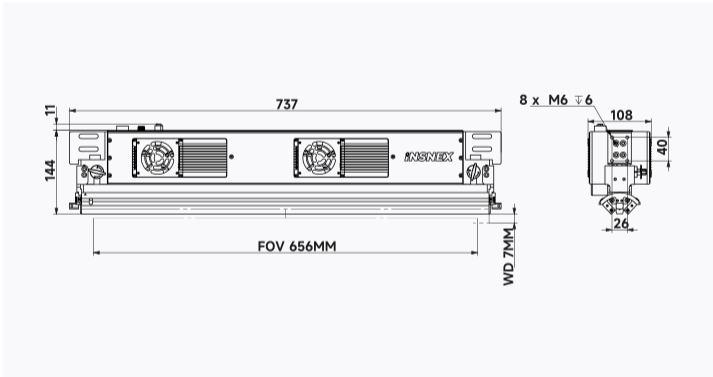


INS-LXM-656-10GM-(9M,9F,18L)

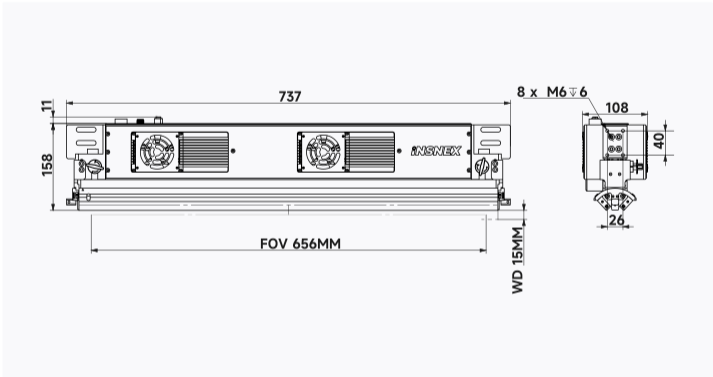


DIMENSION DRAWING (MAX)

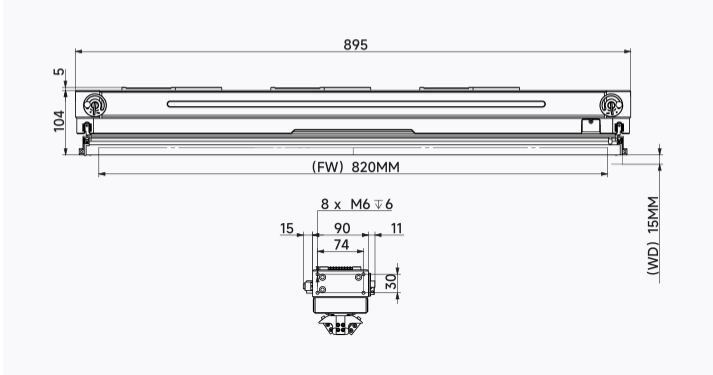
INS-LXM-656-10GM-36L-WD7 PCB



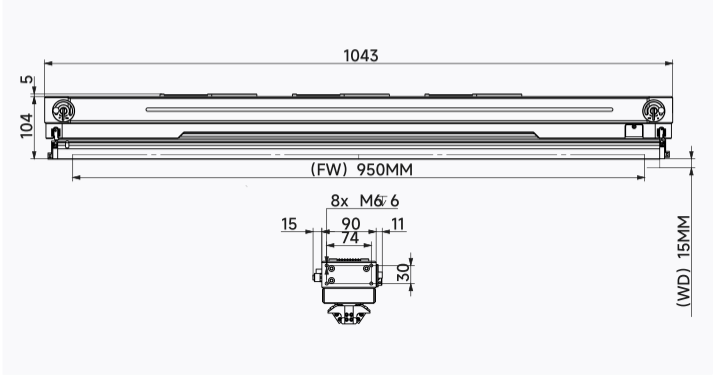
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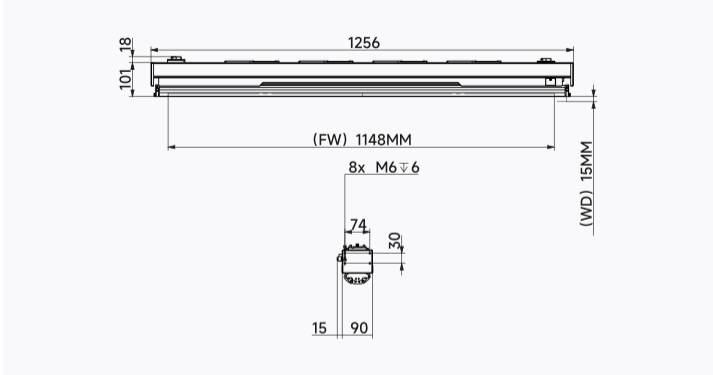
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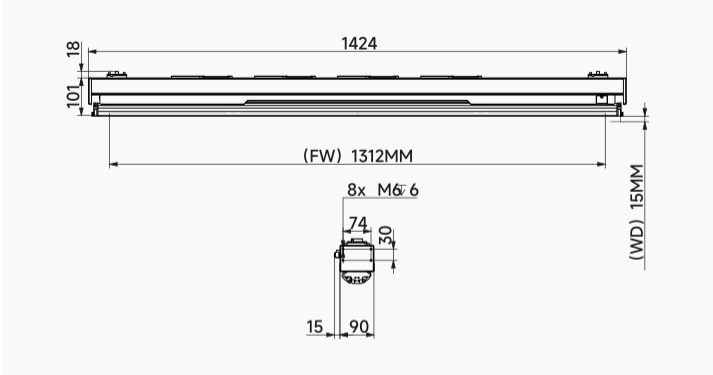
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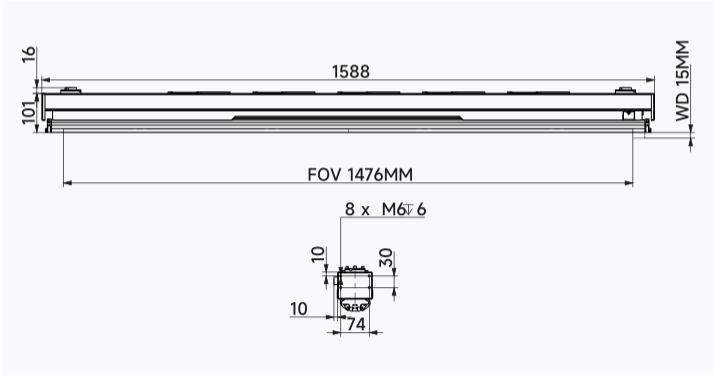
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INS-LXM-1312-10GM-(9M,18L)

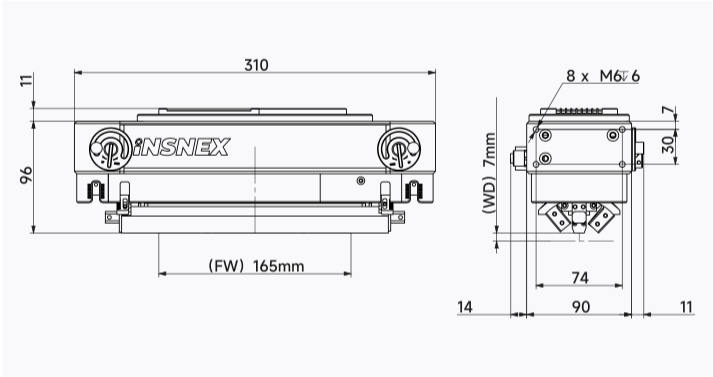


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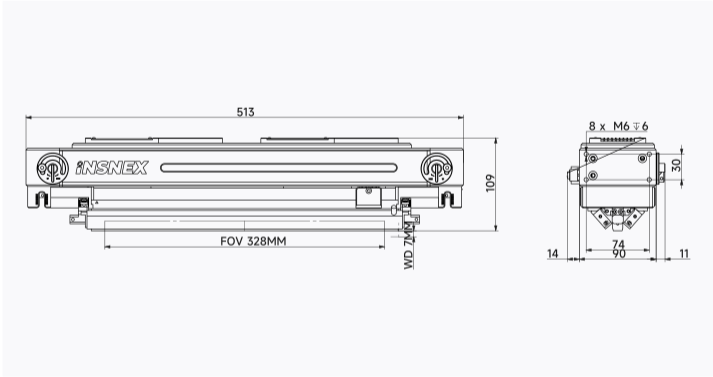


DIMENSION DRAWING (MAX PRO)

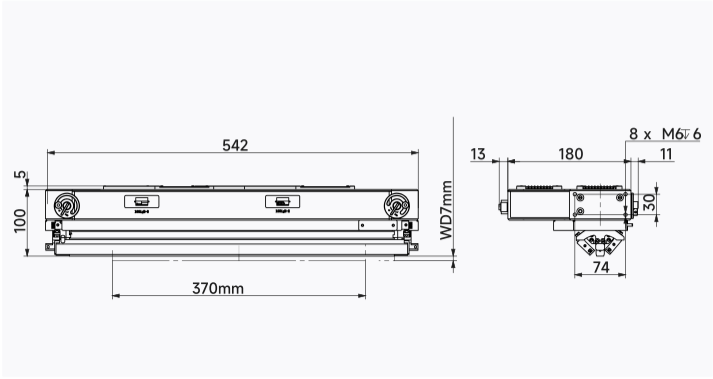
INS-LXM-165-10GM-36L-WD7



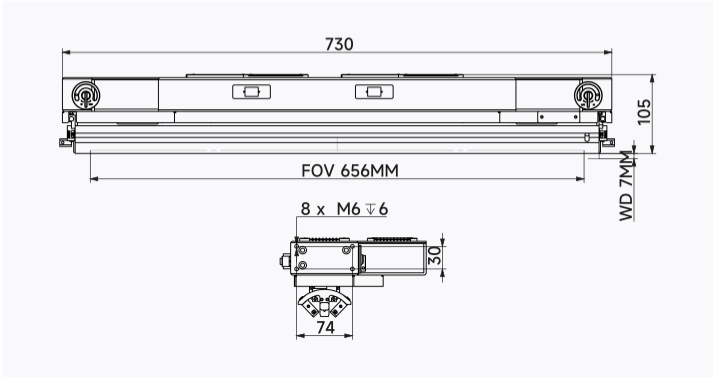
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INS-LXM-360-10GM-36L-WD7

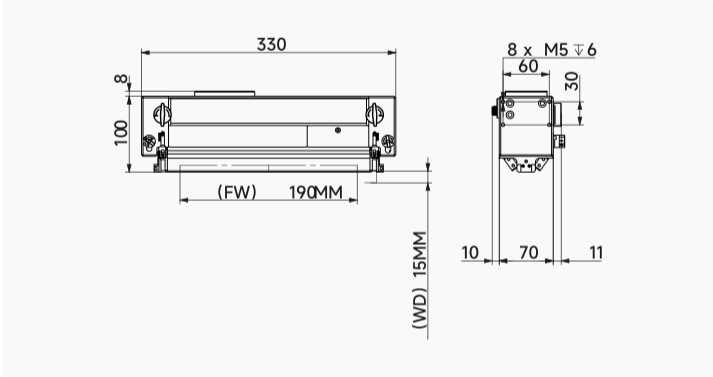


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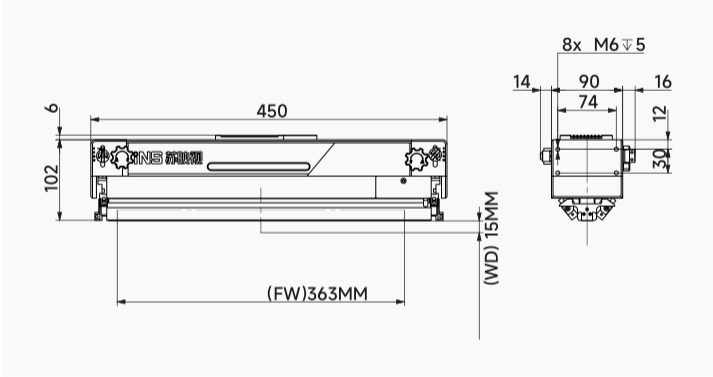


DIMENSION DRAWING (COLOR)

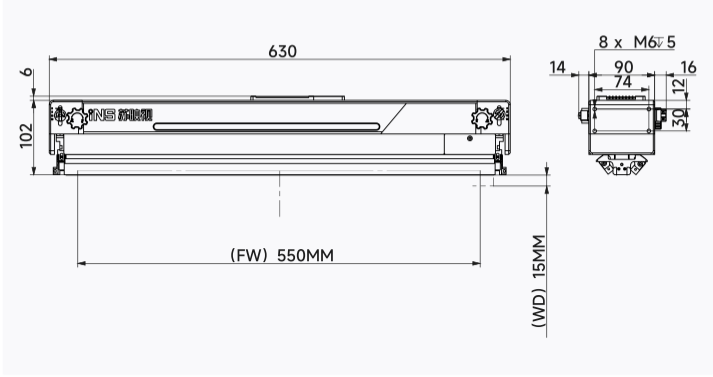
INS-CHVS-190-10GC-BB



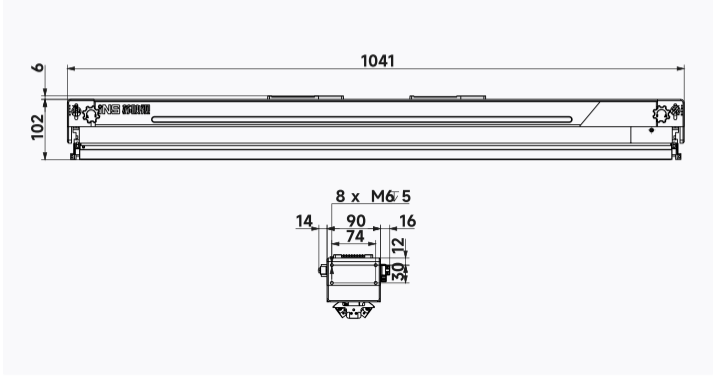
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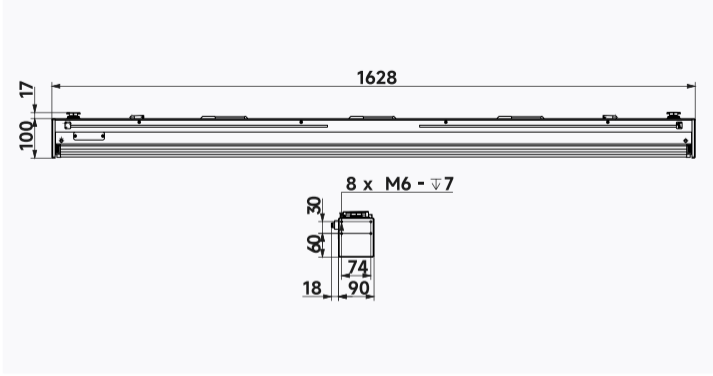
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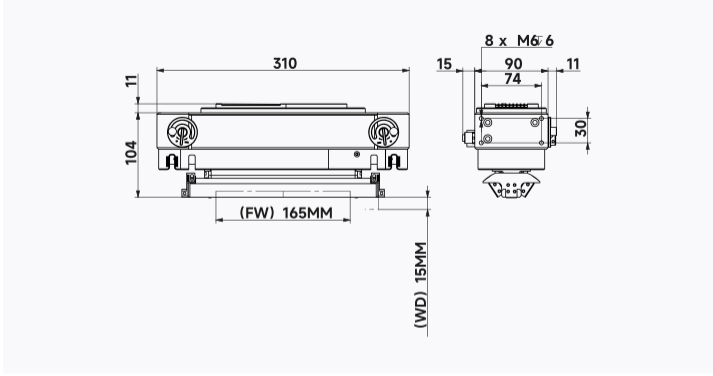
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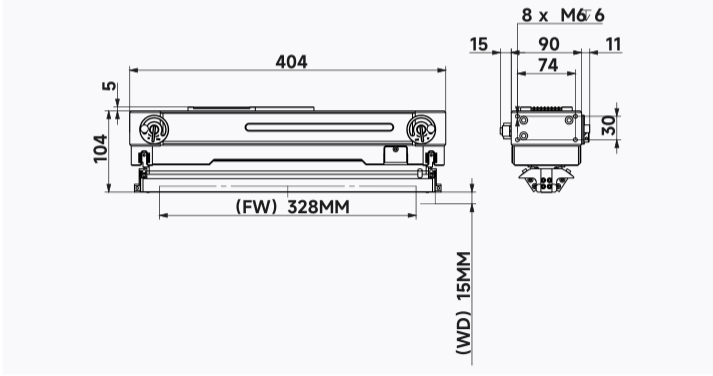
INS-CHVS-1550-10GC-BB



INS-LXM-165-10GC-(18L,9L)



INS-LXM-270-10GC-(18L,9L)





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